

	℃，per diode			
				℃

FIG.1: Forward voltage drop vs forward current

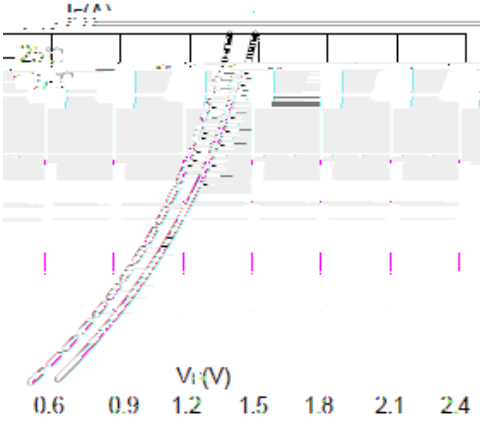
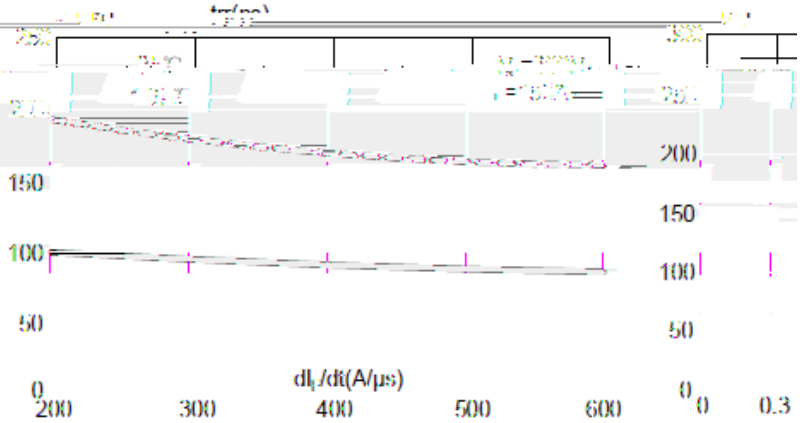


FIG.2: Reverse recovery time vs dI_F/dt



: Reverse recovery current vs dI_F/dt

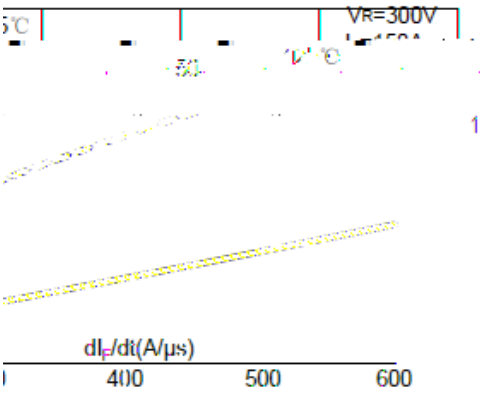


FIG.4: Forward current vs case temperature

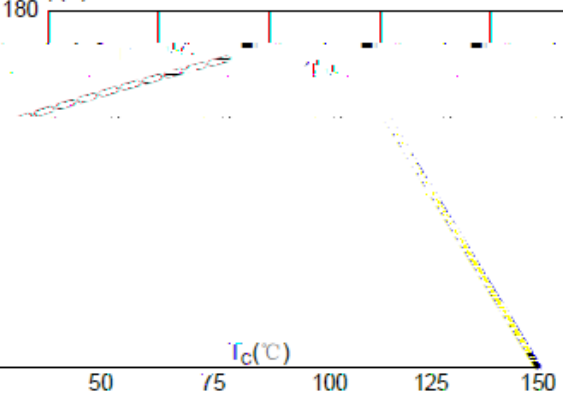


FIG.3:

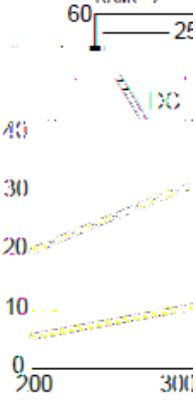
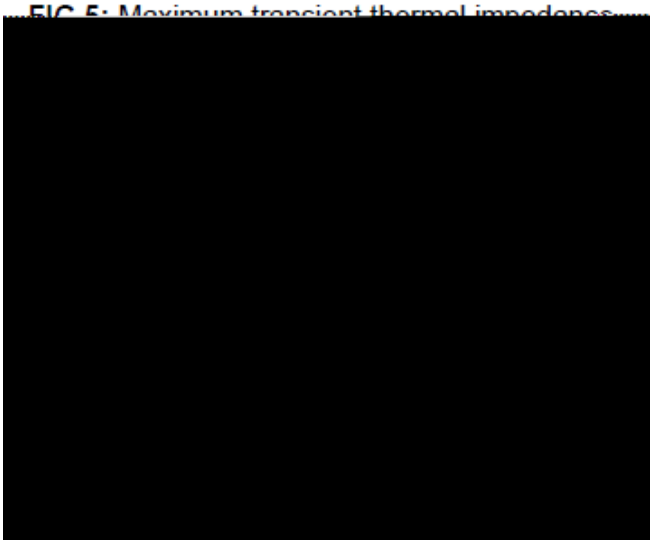
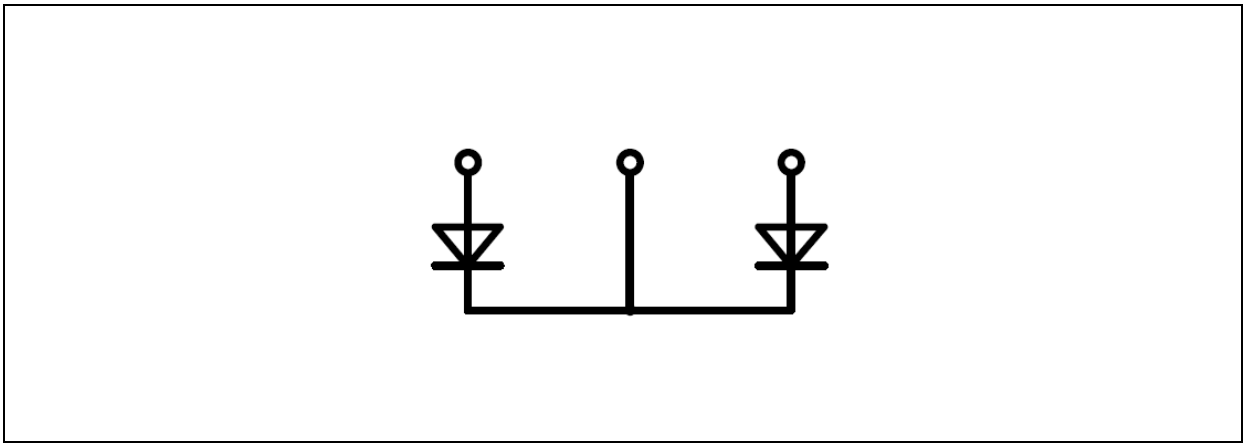
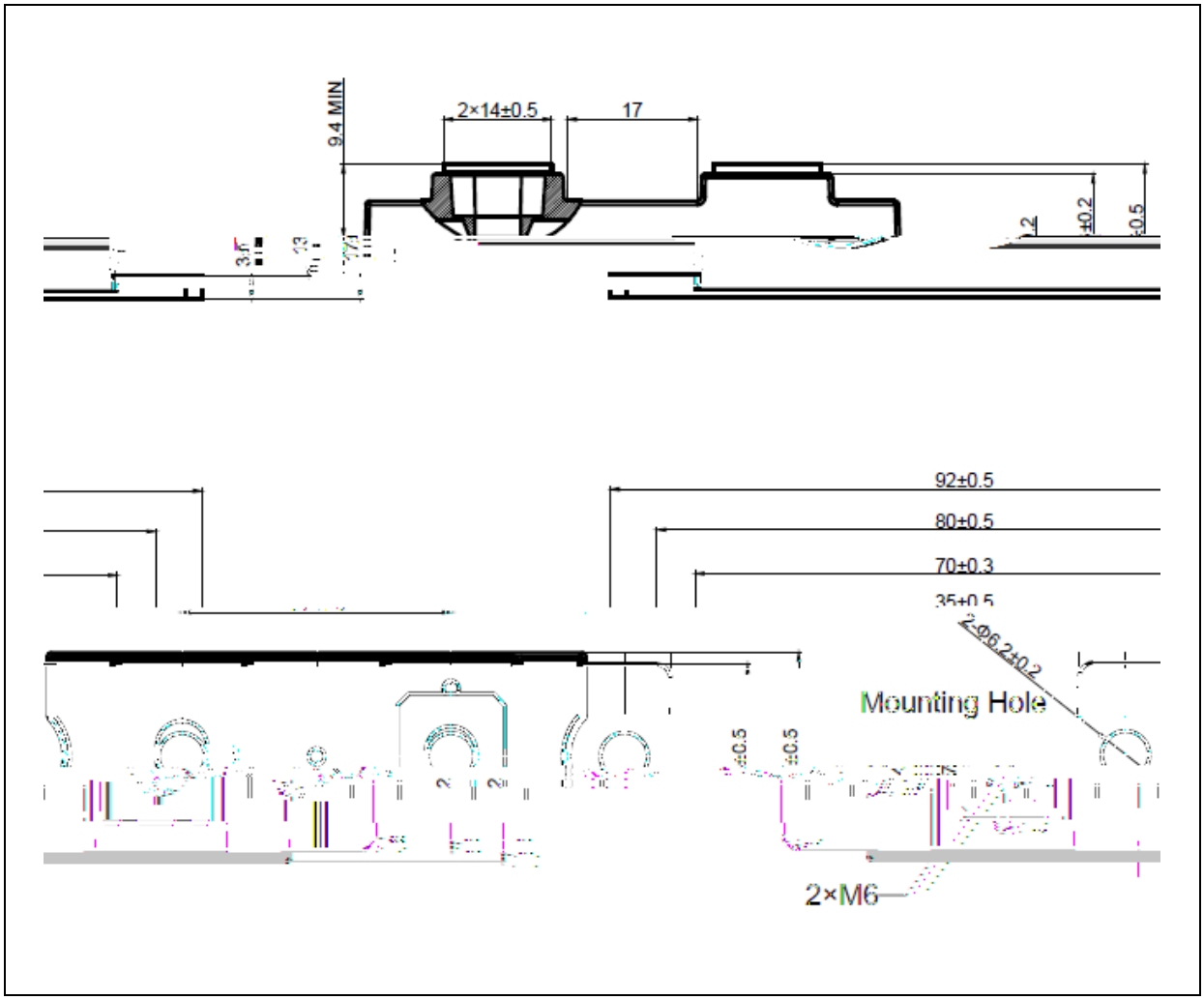


FIG.5: Maximum transient thermal impedance






9.4 MIN
2×14±0.5
17
92±0.5
80±0.5
70±0.3
Mounting Hole
2×M6